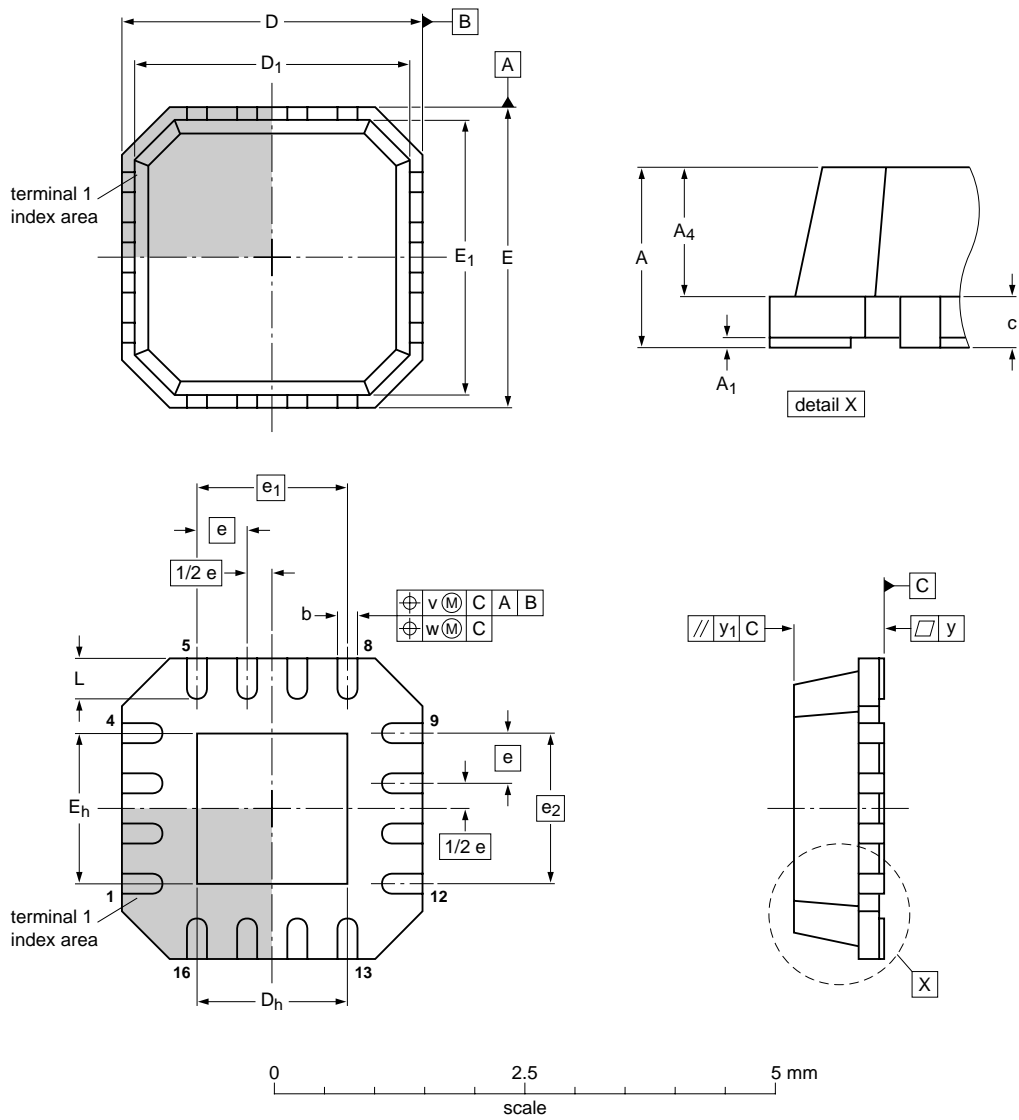


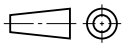
HVQFN16: plastic thermal enhanced very thin quad flat package; no leads;  
16 terminals; body 3 x 3 x 0.85 mm

SOT758-3



DIMENSIONS (mm are the original dimensions)

UNIT	A <sub>max</sub>	A <sub>1</sub>	A <sub>4</sub>	b	c	D	D <sub>1</sub>	D <sub>h</sub>	E	E <sub>1</sub>	E <sub>h</sub>	e	e <sub>1</sub>	e <sub>2</sub>	L	v	w	y	y <sub>1</sub>
mm	0.9	0.05 0.00	0.7 0.6	0.30 0.18	0.2	3.1 2.9	2.85 2.65	1.6 1.4	3.1 2.9	2.85 2.65	1.6 1.4	0.5	1.5	1.5	0.5 0.3	0.1	0.05	0.05	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT758-3		MO-220				07-10-11 08-02-08